



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Material Info	Subsectionals	D, A
Supplier Information									
Company Name	TE Connectivity	Request Document ID		Contact Name	Benfer David W	Contact Title	Product Compliance Engineer for DND		
Company Unique ID	TE Connectivity	Response Date	2018-04-03	Contact Email	dave.benfer@te.com				
Contact Phone Number	717-986-3725								
Legal Statement									
Supplier Acceptance	true								
Legal Statement									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
Product									
Manufacturer Item number	3-1734592-0	Amount	348.052	Version	-	Identity			
Manufacturer Item Name	FPC CONN. 0.5MM PITCH B/C, 30P	Weight Uom	mg	Mfr Site		Authority			
Date		UOM	Each						
EUroHS-0508	Product(s) meets EU RoHS requirement without any exemptions								
ChinaRoHS-0508	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
EUREACH-0117	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
Complex Article Description	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed								
Product Disclosure									
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption
Material	1	HOLD DOWN - TIN PLATING				1.0	0.0265	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.0998999999999999	1.0	2.64735E-5	mg	
Substance	2	Tin	Supplier	7440-31-5	99.9001	1.0	0.02647353	mg	
Material	1	CONTACT - NICKEL PLATING				1.0	0.0098	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	1.0E-5	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.9	1.0	0.0097902	mg	
Material	1	ACTUATOR				1.0	78.0	mg	
Substance	2	Antimony oxide (Sb2O3)	Supplier	1309-64-4	2.0	1.0	1.56	mg	
Substance	2	Glass, oxide, chemicals	Supplier	65997-17-3	45.0	1.0	35.1	mg	
Substance	2	Fatty acids, C18-unsatd., dimers, polymers with ethylenediamine, hexamethylene diamine and propionic acid	Supplier	67989-30-4	53.0	1.0	41.34	mg	
Material	1	HOLD DOWN - NICKEL PLATING				1.0	0.0125	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.9	1.0	0.0124875	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	1.25E-5	mg	
Material	1	CONTACT				1.0	120.0	mg	
Substance	2	Copper	Supplier	7440-50-8	94.15	1.0	112.98	mg	
Substance	2	Phosphorus	Supplier	7723-14-0	0.2	1.0	0.24	mg	
Substance	2	Tin	Supplier	7440-31-5	5.55	1.0	6.66	mg	
Substance	2	Nickel	Nickel	7440-02-0	0.1	1.0	0.12	mg	
Material	1	HOUSING - LCP				1.0	140.0	mg	

Substance	2	1,4-Benzenedicarboxylic acid, polymer with [1,1-biphenyl]-4,4-diol, 4-hydroxybenzoic acid, 6-hydroxy-2-naphthalenecarboxylic acid and N-(4-hydroxyphenyl)acetamide	Supplier	147310-94-9	67.0	1.0	93.8	mg	
Substance	2	Glass, oxide, chemicals	Supplier	65997-17-3	33.0	1.0	46.2	mg	
Material	1	HOLD DOWN				1.0	10.0	mg	
Substance	2	Tin	Supplier	7440-31-5	5.35	1.0	0.535	mg	
Substance	2	Copper	Supplier	7440-50-8	94.45	1.0	9.445	mg	
Substance	2	Phosphorus	Supplier	7723-14-0	0.2	1.0	0.02	mg	
Material	1	CONTACT - GOLD PLATING				1.0	0.0032	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.3	1.0	1.0E-5	mg	
Substance	2	Gold	Supplier	7440-57-5	99.7	1.0	0.0031904	mg	